

FDS9431A-F085

P-Channel 2.5V Specified MOSFET

General Description

This P-Channel 2.5V specified MOSFET is produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize onstate resistance and yet maintain superior switching performance.

• DC/DC converter

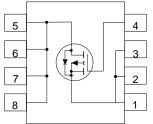
- Power management
- Load switch
- Battery protection

Features

• -3.5 A, -20 V. $R_{DS(ON)} = 0.130 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.180 \ \Omega \ @ V_{GS} = -2.5 \ V.$

- Fast switching speed.
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability.
- Qualified to AEC Q101
- RoHS Compliant





D D D S S S G S S S G S S O-8 S S S G

D



Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
ID	Drain Current - Continuous	(Note 1a)	-3.5	А
	- Pulsed		-18	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
TJ, T _{stg}	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C

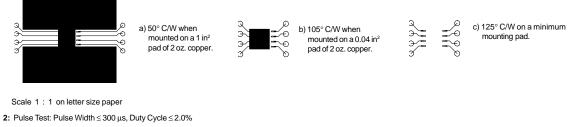
Thermal Characteristics

R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

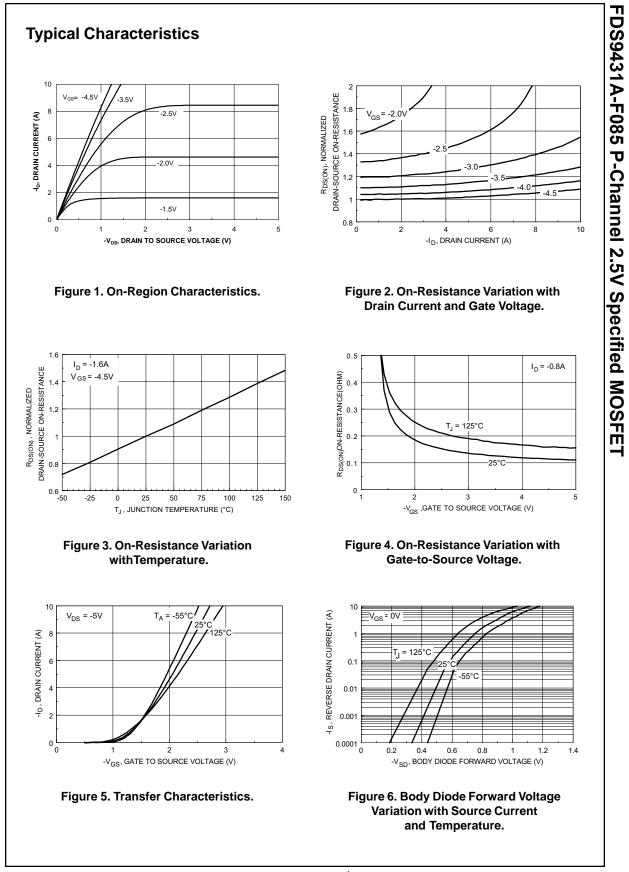
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS9431A	FDS9431A-F085	13"	12mm	2500 units

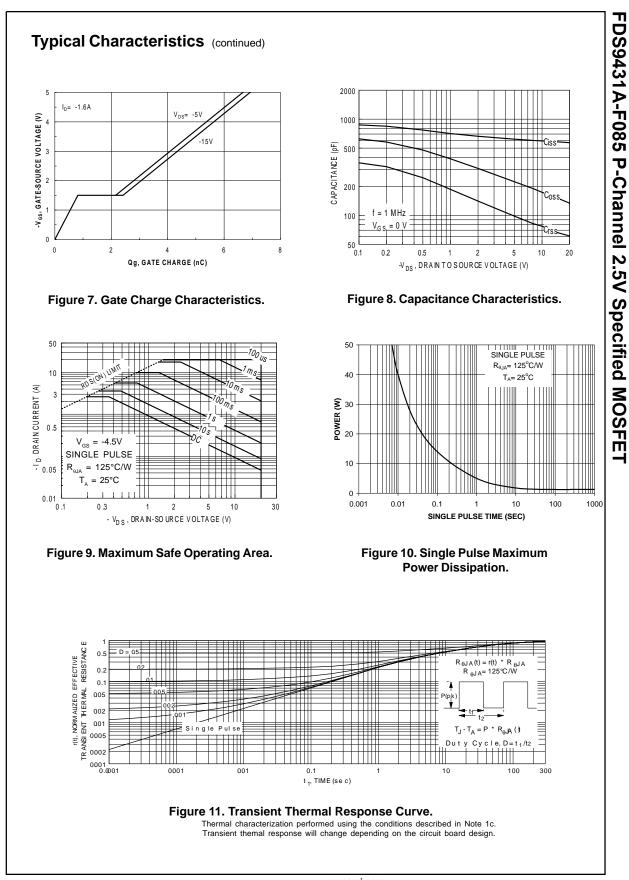
ristics -Source Breakdown Voltage -Source Breakdown Voltage -Source Breakdown Voltage -Source Temperature -Source Temperature -Body Leakage Durrent, -Body Leakage Current, -Source Curr	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ I_D = -250 \ \mu A \\ \\ I_D = -250 \ \mu A, \mbox{Referenced to } 25^\circ \mbox{C} \\ \\ V_{DS} = -16 \ V, \ V_{GS} = 0 \ V \\ \\ V_{GS} = 8 \ V, \ V_{DS} = 0 \ V \\ \\ V_{GS} = -8 \ V, \ V_{DS} = 0 \ V \end{array}$	-20	-28	-1	V mV/°C
-Source Breakdown Voltage kdown Voltage Temperature icient Gate Voltage Drain Current Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	$I_{D} = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$ $V_{DS} = -16 \ \text{V}, \ V_{GS} = 0 \ \text{V}$ $V_{GS} = 8 \ \text{V}, \ V_{DS} = 0 \ \text{V}$	-20	-28		
Gate Voltage Drain Current Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	V _{DS} = -16 V, V _{GS} = 0 V V _{GS} = 8 V, V _{DS} = 0 V		-28	-1	mV/°C
Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	$V_{GS} = 8 V, V_{DS} = 0 V$			-1	
ard Body Leakage Current, rse istics (Note 2)					μA
rse (Note 2)	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
				-100	nA
Threshold Voltege					
Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-0.4	-0.6	-1	V
Threshold Voltage perature Coefficient	I_D = -250 µA,Referenced to 25°C		2		mV/°C
c Drain-Source esistance	$V_{GS} = -4.5 V, I_D = -3.5 A V_{GS} = -2.5 V, I_D = -3.0 A V_{GS} = -4.5 V, I_D = -3.5 A T_i=125^{\circ}C$		0.110 0.140 0.155	0.130 0.180 0.220	Ω Ω Ω
tate Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-10			A
ard Transconductance	V _{DS} = -5 V, I _D = -3.5 A		6.5		S
Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		405		pF
•	t = 1.0 MHz		170		pF
rse Transfer Capacitance			45		pF
aracteristics (Note 2)					
On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$ $V_{GS} = -4.5 V, R_{GEN} = 6 \Omega$		6.5	13	ns
On Rise Time			20	35	ns
Off Delay Time			31	50	ns
Off Fall Time			21	35	ns
Gate Charge	$V_{DS} = -5 V, I_D = -3.5 A, V_{GS} = -4.5 V$		6	8.5	nC
-Source Charge			0.8		nC
-Drain Charge			1.3		nC
Diode Characteristics a	and Maximum Ratings				
mum Continuous Drain-Source	Diode Forward Current			-2.1	A
	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V
	tate Drain Current ard Transconductance racteristics Capacitance ut Capacitance rse Transfer Capacitance aracteristics (Note 2) On Delay Time On Rise Time Off Delay Time Off Fall Time Gate Charge -Drain Charge Diode Characteristics a num Continuous Drain-Source -Source Diode Forward ge	$V_{GS} = -4.5 V, I_D = -3.5 A$ $T_J=125^{\circ}C$ tate Drain Current $V_{GS} = -4.5 V, V_{DS} = -5 V$ ard Transconductance $V_{DS} = -5 V, I_D = -3.5 A$ racteristics Capacitance $V_{DS} = -5 V, I_D = -3.5 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$ $f = 1.0 \text{ MHz}$ $T = 1$	$V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$ T_J=125°Ctate Drain Current $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$ ard Transconductance $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}$ racteristicsCapacitance $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ aracteristics (Note 2)On Delay TimeOn Rise Time $V_{DD} = -5 \text{ V}, I_D = -1 \text{ A}, V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$ Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ Diode Characteristics and Maximum Ratingsnum Continuous Drain-Source Diode Forward Current-Source Diode ForwardV_{GS} = 0 \text{ V}, I_S = -2.1 \text{ A} (Note 2)uncton-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the	$V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$ $T_J=125^{\circ}\text{C}$ tate Drain Current $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$ -10 ard Transconductance $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}$ 6.5 racteristics Capacitance $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz 170 rse Transfer Capacitance $V_{DD} = -5 \text{ V}, I_D = -1 \text{ A},$ V_{GS} = -4.5 V, R_{GEN} = 6 \Omega 20 Off Delay Time Off Fall Time Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A},$ V_{GS} = -4.5 V 0.8 Discret Charge $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A},$ $V_{GS} = -4.5 \text{ V},$ $I_D = -3.5 \text{ A},$	$V_{GS} = -4.5 V$, $I_D = -3.5 A$ 0.155 0.220 tate Drain Current $V_{GS} = -4.5 V$, $V_{DS} = -5 V$ -10 -10 ard Transconductance $V_{DS} = -5 V$, $I_D = -3.5 A$ 6.5 -10 racteristics Capacitance $V_{DS} = -10 V$, $V_{GS} = 0 V$, tf = 1.0 MHz 405 -10 aracteristics Capacitance $V_{DS} = -10 V$, $V_{GS} = 0 V$, tf = 1.0 MHz 405 -10 aracteristics (Note 2) On Delay Time $V_{DD} = -5 V$, $I_D = -1 A$, $V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$ 20 35 Off Delay Time $V_{DS} = -5 V$, $I_D = -3.5 A$, $V_{GS} = -4.5 V$ 6 8.5 Source Charge $V_{DS} = -5 V$, $I_D = -3.5 A$, $V_{GS} = -4.5 V$ 0.8



www.onsemi.com 2



www.onsemi.com



www.onsemi.com

4

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights or others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative